

THE DATASHEET OF FH67-20S-0.5SV

APPLICA	BLE STAN	DARD										
Operating temperature		range	-55 °C to 125 °C (n	ote 6)	Storage temperature range			-10℃ TO 60℃(Packed condition)				
RATING	Voltage		humid		humidi	idity range		Re	Relative humidity 90 % MAX (Not de			
	Current	0.50 A			(FPC/F	able cat FC)	DIE		t=0.33±0.03mm, Gold (Ground plate : Tin p		_	
			SPEC	IFICA	10IT	NS						
	ГЕМ		TEST METHOD				RI	EQU	IREMENTS	QT	АТ	
	RUCTION	_				1						
General examination			and by measuring instrumen	nt.		According to drawing. (note 1)			×	×		
Marking			d visually.			(Hote	1)			×	×	
	ICAL CHA					T			-			
Voltage proof		150 V AC for 1 min.				No flashover or breakdown.				×	_	
Insulation resistance		100 V DC.				500 MΩ MIN.				×	-	
Contact resistance						[FPC] Initial:60 mΩ MAX、After each test:80 mΩ MAX (Including bulk resistance L=8mm)			×	-		
						[FFC] Initial:80 m Ω MAX、After each test:100 m Ω MAX (Including bulk resistance L=26mm)						
	NICAL CHA											
Vibration		Frequency 10 to 55 Hz, half amplitude 0.75 mm, for 10 cycles in 3 axial directions.				① No electrical discontinuity of 1 μs.			×	-		
Shock		981 m/s ² , duration of pulse 6 ms				② Contact resistance: 80 mΩ MAX(FPC) 100. mΩ MAX(FFC)				×	—	
		at 3 times	s in 3 both axial directions.			No damage, crack and looseness of parts.						
Mechanical operation		10 times insertions and extractions.				① Contact resistance: 80 mΩ MAX(FPC) 100. mΩ MAX(FFC)			×	-		
FPC/FFC		Measured by applicable FPC/FFC.			② No damage, crack and looseness of parts. Insertion force: Direction of insertion			×	+_			
insertion/extraction force		(Thickness of FPC/FFC shall be t=0.33mm at initial condition.)			(n : Number of contacts) 2+0.35×n N MAX (FPC/FFC) (<i>note 2</i>) 2+0.41×n N MAX (Shielded FFC) (<i>note 2</i>) Extraction force : Direction of extraction (n : Number of contacts) 4+0.32×n N MAX (FPC/FFC) (<i>note 2</i>) 4+0.42×n N MAX (Shielded FFC) (<i>note 2</i>)							
FPC/FFC		Measured by applicable FPC/FFC.			Direction of extraction				×	+_		
retention force		(Thickness of FPC/FFC shall be t=0.33mm at initial condition.)			(n : Number of contacts) 18+0.08×n N MIN (FPC/FFC) (note3) 15+0.1×n N MIN (Shielded FFC) (note3)							
ENVIRO	NMENTAL	CHARA	ACTERISTICS			101	0.121111		(Officiaca 1 1 0) (Notes)			
Rapid change of Tetemperature Til		Temperature-55 \rightarrow +15TO+35 \rightarrow +125 \rightarrow +15TO+35 $^{\circ}$ C Time 30 \rightarrow 2 to 3 \rightarrow 30 \rightarrow 2 to 3 min Under 1000 cycles.			① Contact resistance: 80 mΩ MAX(FPC) 100. mΩ MAX(FFC) ② Insulation resistance: 50 MΩ MIN.			×	_			
Damp heat (Steady state)		Exposed at 60±2 °C, Relative humidity 90 to 95 %, 96 h.				No damage, crack and looseness of parts.				×	-	
Damp heat,cyclic		Exposed at -10 to +65 °c, Relative humidity 90 to 96 %, 10 cycles, TOTAL 240 h.			 Contact resistance: 80 mΩ MAX(FPC) 100. mΩ MAX(FFC) Insulation resistance: 1 MΩ MIN. (At high humidity) Insulation resistance: 50 MΩ MIN. (At dry) 			×	_			
				_		④ No	damage,	cracl	and looseness of parts			
COUN 1	IT DE		ON OF REVISIONS		DESIG				CHECKED		DATE 20200615	
REMARK	N12-1-		F-00006186		KN. KOBA	APPRO		HS. HIRAHARA /ED HH. SHINDO			80517	
INCINITALIA						CHECKE		ED	D KN. SHIBUYA		80517	
Unloss otherwise enecified to			efer to IEC 60512					SI. TAMAKI	20180516			
Unless otherwise specified, refer to IEC 60512.				DRAWN DS. HIROWATARI								
Note QT:Qualification Test AT:Assurance Test SPECIFICATION HIROSE ELECTRIC				Test	st DR.		RAWING NO.		ELC-370364-00 FH67-**S-0. 5SV		0	
			CATION SHEET LECTRIC CO., LTD.		CODE		-			<u>A</u>	1/2	
FORM HD0011					CODE	INU.			ULUUU	<u> </u>	1/2	

	SPECIFICATIO	NS		
ITEM	TEST METHOD	REQUIREMENTS	QT	AT
Dry heat	Exposed at 125±2°C, 1000 h.	① Contact resistance: 80 mΩ MAX(FPC)	×	_
Cold	Exposed at -55±3°C, 1000 h.	100. mΩ MAX(FFC) ② No damage, crack and looseness of parts	×	-
Sulphur dioxide [JIS C 60068-2-42]	Exposed at 40 ± 2 °C, Relative humidity $80\pm5\%$ 25 ± 5 ppm for 96 h.	① Contact resistance: 80 mΩ MAX(FPC) 100. mΩ MAX(FFC)	×	_
Solderability	Soldered at solder temperature, 245±0.3°C for immersion duration,3±0.3 sec.	A new uniform coating of solder shall cover a minimum of 95 % of the surface being immersed.	×	_
Resistance to soldering heat	1) Reflow soldering: Peak TMP. 250 °C MAX. Reflow TMP. over 220 °C 60 to 90 sec. Number of reflow: 2 times 2) Soldering irons: TMP. 350±10 °C for 5±1 sec.	No deformation of case of excessive looseness of the terminals. (<i>note 4</i>)	×	_

(note 1)

This product features "One Action Lock" and vertical mount.

"One Action Lock" completes FPC/FFC lock just by inserting the FPC/FFC.

Do not operate the actuator when inserting the FPC/FFC.

(note 2)

Do not insert the FPC/FFC to this product at an angle.

(note 3)

Stabilize the FPC/FFC to PCB or something fixed, if pull-up or pull-down force is exepected to be applied to the FPC/FFC.

There's a case witch FPC/FFC retention force doesn't fulfill the value, because FPC/FFC specification affects the result of FPC/FFC retention force.

(note 4)

Blisters which may be generated on the housing do not affect product performance.

(note 5)

The occurrence and the length of whisker, and the performance deterioration caused by it are out of the scope of this specification



4 (note 6)

The heat resistant temperature when using FFC is 105°C.

When the heat resistant temperature of FPC/FFC is less than 125°C/105°C, the heat resistant temperature of FPC/FFC is applied.

Note QT:0	Qualification Test AT:Assurance Test X:Applicable Test	DRAWIN	NG NO.	ELC-370364-00-00		
HS	SPECIFICATION SHEET	PART NO.	FH67-**S-0. 5SV			
1.0	HIROSE ELECTRIC CO., LTD.	CODE NO		CL580	A	2/2